TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

TCR2EF series TCR2EE series

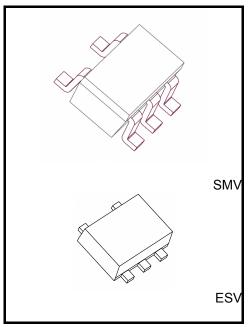
200 mA CMOS Low Drop-Out Regulator with Fast Load Transient Response

The TCR2EF and TCR2EE series are CMOS single-output voltage regulators with an on/off control input, featuring low dropout voltage, low output noise voltage and fast load transient response.

These voltage regulators are available in fixed output voltages between 1.0 V and 5.0 V and capable of driving up to 200 mA. They feature overcurrent protection, an Auto-discharge function.

The TCR2EF and TCR2EE series has a low dropout voltage of 180 mV (2.5 V output, I_{OUT} = 150 mA) with low output noise voltage of 35 μV_{rms} (2.5 V output) and a load transient response of only \triangle V_{OUT} = \pm 60 mV (I_{OUT} = 1 mA \Leftrightarrow 150 mA, C_{OUT} =1.0 μ F).

Thus, the TCR2EF and TCR2EE series are suitable for sensitive power supply such as Analog and RF applications.



Weight:

SMV (SOT-25)(SC-74A) : 16 mg (typ.) ESV (SOT-553) : 3.0 mg (typ.)

Features

Low Drop-Out voltage

 V_{IN} - V_{OUT} = 150 mV (typ.) at 3.0 V-output, I_{OUT} = 150 mA

 $V_{\text{IN}}\text{-}V_{\text{OUT}}$ = 180 mV (typ.) at 2.5 V-output, I_{OUT} = 150 mA

 V_{IN} - V_{OUT} = 230 mV (typ.) at 1.8 V-output, I_{OUT} = 150 mA

 V_{IN} - V_{OUT} = 380 mV (typ.) at 1.2 V-output, I_{OUT} = 150 mA

 V_{IN} - V_{OUT} = 510 mV (typ.) at 1.0 V-output, I_{OUT} = 150 mA

- Low output noise voltage (V_{NO} = 35 μV_{rms} (typ.) at 2.5 V-output, I_{OUT} = 10 mA, 10 Hz < f < 100 kHz)
- Fast load transient response (∠IV_{OUT} = ±60 mV (typ.) at I_{OUT} = 1 mA ⇔ 150 mA, C_{OUT} =1.0 μF)
- Low quiescent bias current ($I_B = 35 \mu A \text{ (typ.)}$ at $I_{OUT} = 0 \text{ mA}$)
- High ripple rejection (R.R = 73 dB (typ.) at 2.5V-output, I_{OUT} = 10 mA, f = 1 kHz)
- Wide range Output Voltage line up (V_{OUT} = 1.0 to 5.0 V)
- High V_{OUT} accuracy ±1.0% (1.8V ≤ V_{OUT})
- Overcurrent protection
- Auto-discharge
- Pull down connection between CONTROL and GND
- Ceramic capacitors can be used (C_{IN} = 0.1 μ F, C_{OUT} = 1.0 μ F)
- Small package ESV (SOT-553) (1.6 mm x 1.6 mm x 0.55 mm)
 General package SMV (SOT-25) (2.8 mm x 2.9 mm x 1.1 mm)



Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating		Unit		
Input voltage	V _{IN}	6.0			V	
Control voltage	V _{CT}	-0.3 to 6.0			V	
Output voltage	V _{OUT}	-0.3 to V _{IN} + 0.3			V	
Output current	Гоит	200			mA	
Power dissipation		CM)/	200	(Note 1)		
	P _D	SMV	580	(Note 2)	mW	
		PD	ECV/	150	(Note 1)	IIIVV
		ESV	320	(Note 3)		
Operation temperature range	T _{opr}	-40 to 85			°C	
Junction temperature	Tj	150			°C	
Storage temperature range	T _{stg}	-55 to 150			°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Unit Rating

Note 2: Rating at mounting on a board

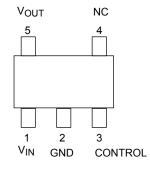
(FR4 board: 25.4 mm \times 25.4 mm \times 1.6 mm)

Note 3: Rating at mounting on a board

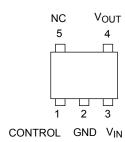
(FR4 board dimension: 30 mm \times 30 mm \times 0.8 mm)

Pin Assignment (top view)

SMV(SOT-25)(SC-74A)



ESV(SOT-553)





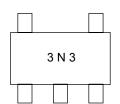
List of Products Number, Output voltage and Marking

Produ	Product No. Vout (Marking	Product No.		V _{OUT} (V)	Marking
SMV(SOT-25)	ESV(SOT-553)	(typ.)		SMV(SOT-25)	ESV(SOT-553)	(typ.)	Manung
TCR2EF10	TCR2EE10	1.0	1N0	TCR2EF28	TCR2EE28	2.8	2N8
TCR2EF105	TCR2EE105	1.05	1NA	TCR2EF285	TCR2EE285	2.85	2ND
TCR2EF11	TCR2EE11	1.1	1N1	TCR2EF29	TCR2EE29	2.9	2N9
TCR2EF115	TCR2EE115	1.15	1NB	-	TCR2EE295	2.95	2NE
TCR2EF12	TCR2EE12	1.2	1N2	TCR2EF30	TCR2EE30	3.0	3N0
TCR2EF125	TCR2EE125	1.25	1NC	-	TCR2EE305	3.05	3NA
TCR2EF13	TCR2EE13	1.3	1N3	TCR2EF31	TCR2EE31	3.1	3N1
TCR2EF135	TCR2EE135	1.35	1ND	TCR2EF32	TCR2EE32	3.2	3N2
TCR2EF14	TCR2EE14	1.4	1N4	TCR2EF33	TCR2EE33	3.3	3N3
-	TCR2EE145	1.45	1NE	-	TCR2EE335	3.35	3ND
TCR2EF15	TCR2EE15	1.5	1N5	-	TCR2EE34	3.4	3N4
-	TCR2EE17	1.7	1N7	TCR2EF36	TCR2EE36	3.6	3N6
TCR2EF18	TCR2EE18	1.8	1N8	-	TCR2EE39	3.9	3N9
-	TCR2EE185	1.85	1NF	TCR2EF40	TCR2EE40	4.0	4N0
TCR2EF19	TCR2EE19	1.9	1N9	TCR2EF41	TCR2EE41	4.1	4N1
TCR2EF20	TCR2EE20	2.0	2N0	-	TCR2EE42	4.2	4N2
-	TCR2EE24	2.4	2N4	TCR2EF45	TCR2EE45	4.5	4N5
TCR2EF25	TCR2EE25	2.5	2N5	-	TCR2EE48	4.8	4N8
TCR2EF27	TCR2EE27	2.7	2N7	TCR2EF50	TCR2EE50	5.0	5N0
-	TCR2EE275	2.75	2NF				

Please ask your local retailer about the devices with other output voltages.

Marking (top view)

Example: TCR2EF33 (3.3 V output) Example: TCR2EE33 (3.3 V output)







Electrical Characteristics (Unless otherwise specified,

 $V_{IN} = V_{OUT} + 1 \ V, \ I_{OUT} = 50 \ mA, \ C_{IN} = 0.1 \ \mu F, \ C_{OUT} = 1.0 \ \mu F, \ T_j = 25^{\circ}C)$

Characteristics	Symbol	Test Condition		Min	Тур.	Max	Unit
Output voltage accuracy	Vout	50 4 (1) 4	V _{OUT} < 1.8 V	-18	_	+18	mV
Output voltage accuracy	VOU1	I _{OUT} = 50 mA (Note 4)	1.8 V ≤ V _{OUT}	-1.0	_	+1.0	%
Input voltage	V _{IN}	I _{OUT} = 1 mA		1.5	_	5.5	V
Line regulation	Reg·line	V _{OUT} + 0.5 V ≤ V _{IN} ≤ 5.5	5 V, I _{OUT} = 1 mA	_	1	15	mV
Load regulation	Reg·load	1 mA ≤ I _{OUT} ≤ 150 mA		_	15	30	mV
Quiescent current	IB	I _{OUT} = 0 mA	_	35	60	μА	
Stand-by current	I _{B (OFF)}	V _{CT} = 0 V	_	0.1	1.0	μА	
Drop-out voltage	V _{IN} -V _{OUT}	I _{OUT} = 150 mA (Note 5	_	180	230	mV	
Temperature coefficient	T _{CVO}	–40°C ≤ T _{opr} ≤ 85°C		_	100	_	ppm/°C
Output noise voltage	V _{NO}	$V_{IN} = V_{OUT} + 1 \text{ V, } I_{OUT} = 10 \text{ mA,}$ 10 Hz \leq f \leq 100 kHz, Ta = 25°C (Note 5)		_	35	_	μV _{rms}
Ripple rejection ratio	R.R.	$V_{IN} = V_{OUT} + 1 V$, I_{OUT} $f = 1 \text{ kHz}$, $V_{Ripple} = 500$ $Ta = 25^{\circ}C$ (Note 5)	_	73	_	dB	
Load transient response	⊿Vouτ	I _{OUT} = 1 mA⇔150mA, C _{OUT} = 1.0 μF		_	±60	_	mV
Control voltage (ON)	V _{CT} (ON)	_		1.0	_	5.5	V
Control voltage (OFF)	V _{CT (OFF)}	_		0	_	0.4	V

Note 4: Stable state with fixed I_{OUT} condition

Note 5: The 2.5 V output product

Note 6: All characterisitcs of over 4.5V output products are measured at $V_{IN} = V_{OUT} + 0.5 \text{ V}$ conditions.

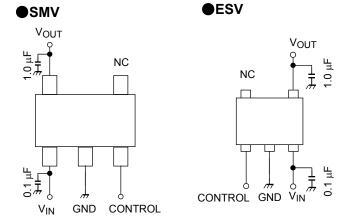
Drop-out voltage ($I_{OUT} = 150 \text{ mA}$, $C_{IN} = 0.1 \mu\text{F}$, $C_{OUT} = 1.0 \mu\text{F}$, $T_j = 25^{\circ}\text{C}$)

Output voltages	Symbol	Min	Тур.	Max	Unit
1.0 V, 1.05 V		_	510	770	
1.1 V, 1.15 V		_	440	670	
1.2 V, 1.25 V		_	380	570	
1.3 V		_	350	470	
1.4 V	V _{IN} - V _{OUT}	_	310	420	mV
1.5 V ≤ V _{OUT} < 1.8 V		_	290	390	
1.8 V ≤ V _{OUT} < 2.5 V		_	230	310	
2.5 V ≤ V _{OUT} < 3.0 V		_	180	230	
3.0 V ≤ V _{OUT} ≤ 5.0 V		_	150	200	



Application Note

1. Recommended Application Circuit



CONTROL pin connection	Operation	
HIGH	ON	
LOW	OFF	
OPEN	OFF	

The figure above shows the recommended configuration for using a Low-Dropout regulator. Insert a capacitor at V_{OUT} and V_{IN} pins for stable input/output operation. (Ceramic capacitors can be used).

2. Power Dissipation

Both unit and board-mounted power dissipation ratings for TCR2EF series and TCR2EE series are available in the Absolute Maximum Ratings table.

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Power dissipation is measured on the board shown below.

Testing Board of Thermal Resistance

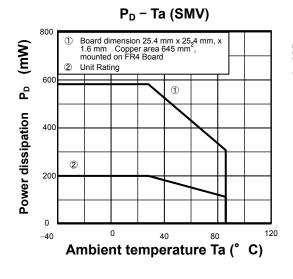
SMV ESV

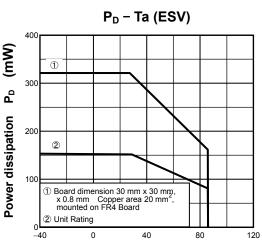
*Board material: FR4 board

Board dimension: 25.4 mm × 25.4 mm × 1.6 mm

Copper area: 645 mm²

*Board material: FR4 board Board dimension: $30 \text{ mm} \times 30 \text{ mm} \times 0.8 \text{ mm}$ Copper area: 20 mm^2





Ambient temperature Ta (° C)

Attention in Use

Output Capacitors

Ceramic capacitors can be used for these devices. However, because of the type of the capacitors, there might be unexpected thermal features. Please consider application condition for selecting capacitors. And Toshiba recommend the ESR of ceramic capacitor is under 10 Ω .

Mounting

The long distance between IC and output capacitor might affect phase assurance by impedance in wire and inductor. For stable power supply, output capacitor need to mount near IC as much as possible. Also VIN and GND pattern need to be large and make the wire impedance small as possible.

Permissible Loss

Please have enough design patterns for expected maximum permissible loss. And under consideration of surrounding temperature, input voltage, and output current etc, we recommend proper dissipation ratings for maximum permissible loss; in general maximum dissipation rating is 70 to 80 percent.

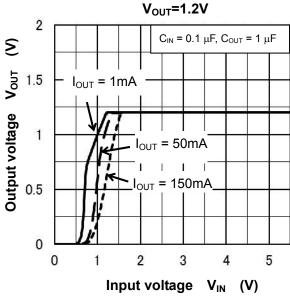
Overcurrent Protection Circuit

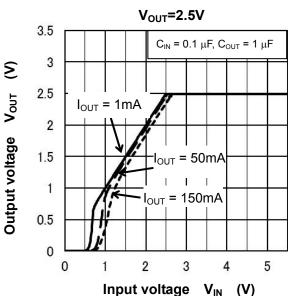
Overcurrent protection circuit is designed in these products, but this does not assure for the suppression of uprising device operation. If output pins and GND pins are shorted out, these products might be break down.

In use of these products, please read through and understand dissipation idea for absolute maximum ratings from the above mention or our 'Semiconductor Reliability Handbook'. Then use these products under absolute maximum ratings in any condition. Furthermore, Toshiba recommend inserting failsafe system into the design.

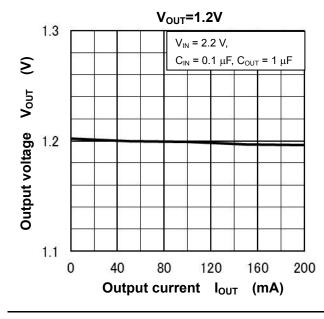
Representative Typical Characteristics

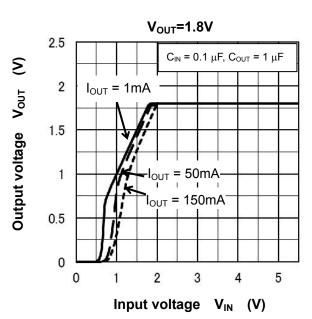
1) Output Voltage vs. Input Voltage

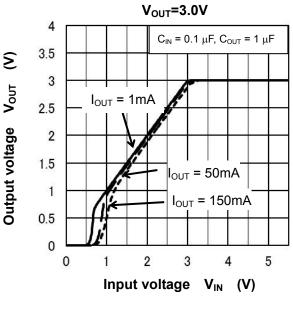


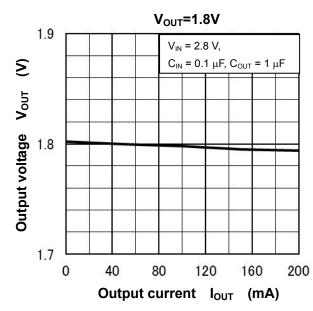


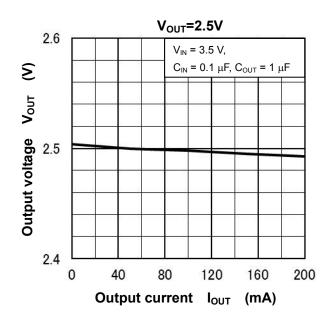
2) Output Voltage vs. Output Current

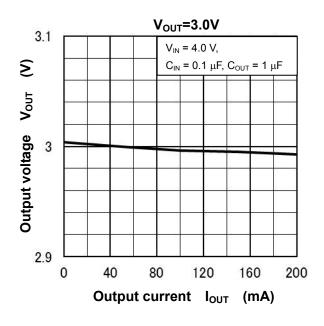




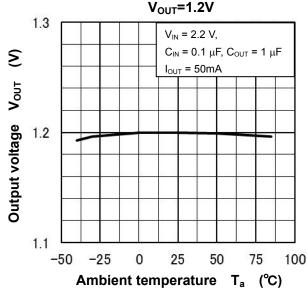


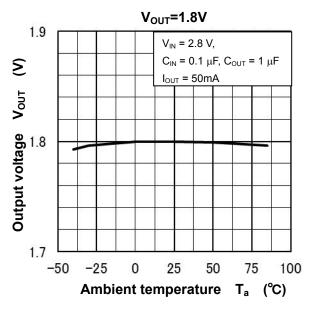


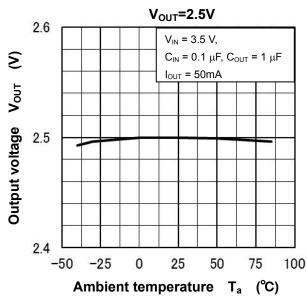


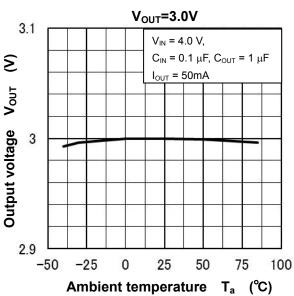


3) Output Voltage vs. Ambient Temperature

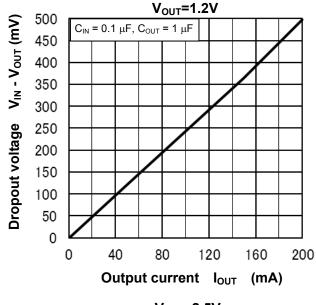


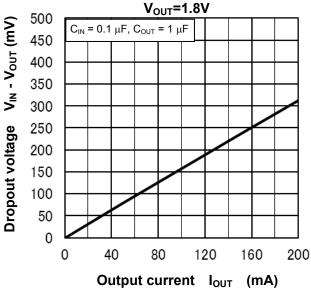


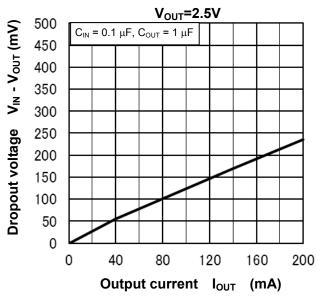


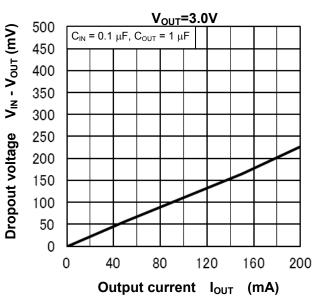


4) Dropout Voltage vs. Output Current

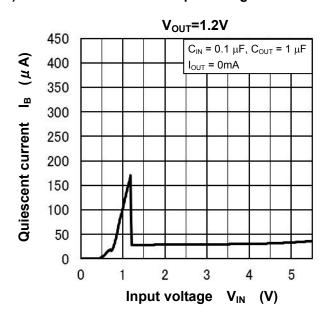


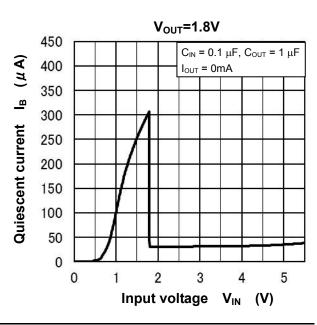


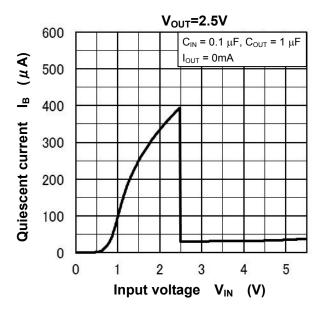


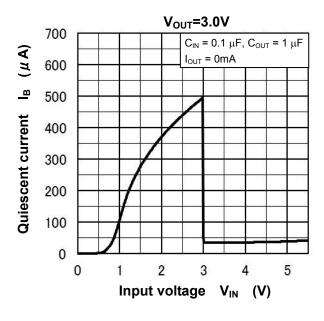


5) Quiescent Current vs. Input Voltage

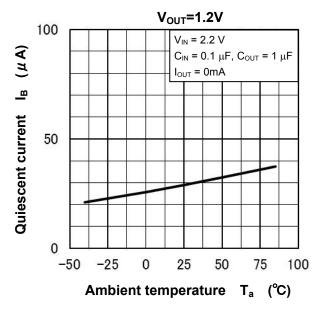


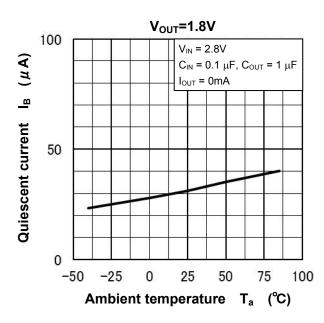


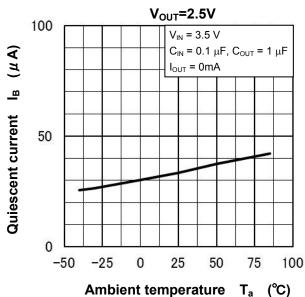


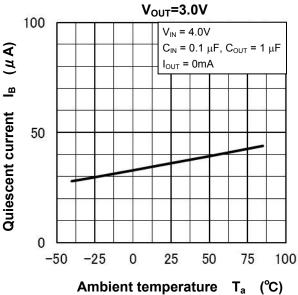


6) Quiescent Current vs. Ambient Temperature

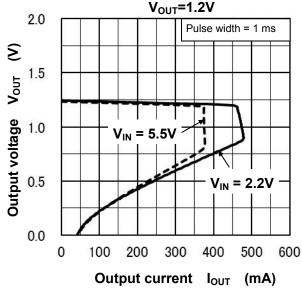


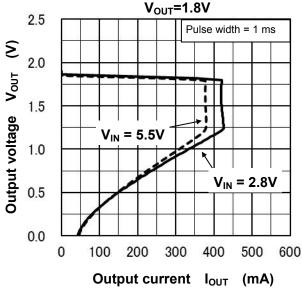


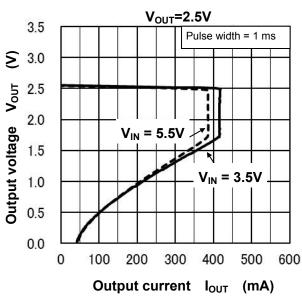


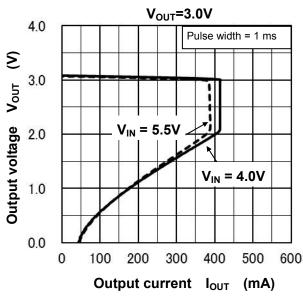


7) Output Voltage vs. Output Current

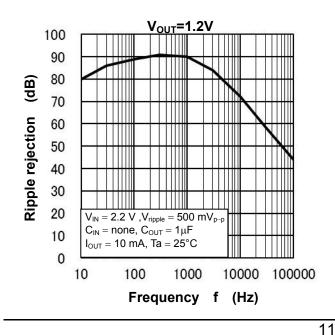


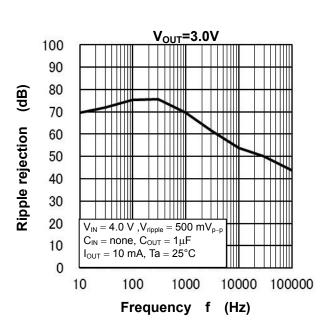




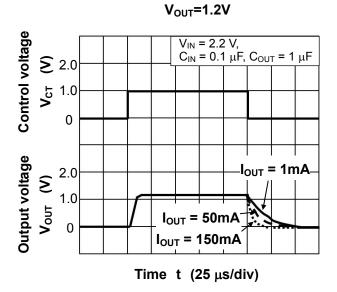


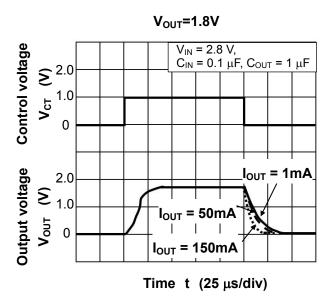
8) Ripple Rejection Ratio vs. Frequency

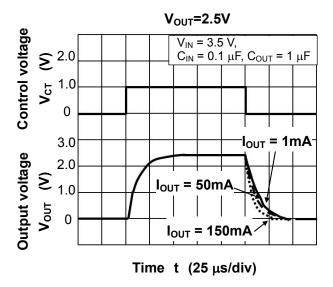


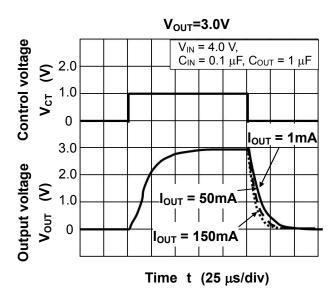


9) Control Transient Response



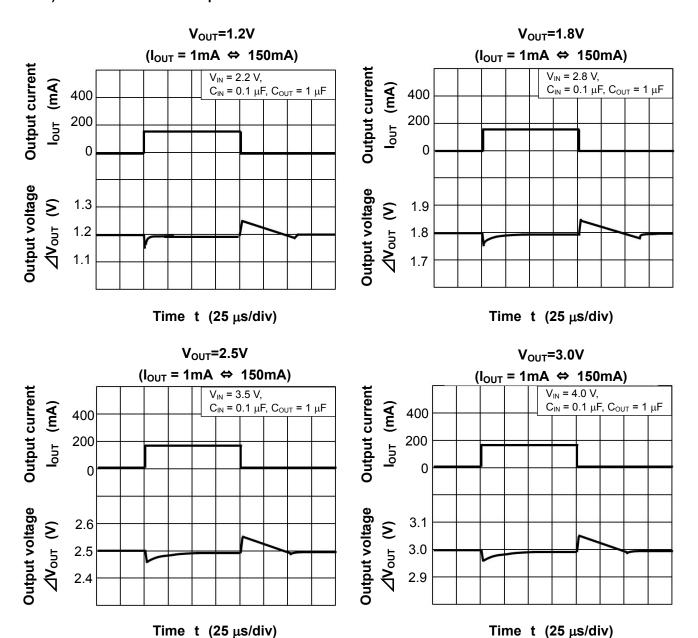








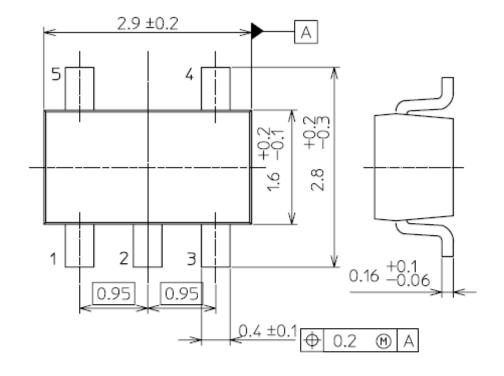
10) Control Transient Response

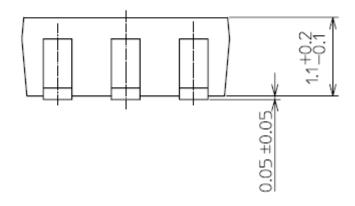




Package Dimensions SMV (SOT-25)(SC-74A)

Unit: mm

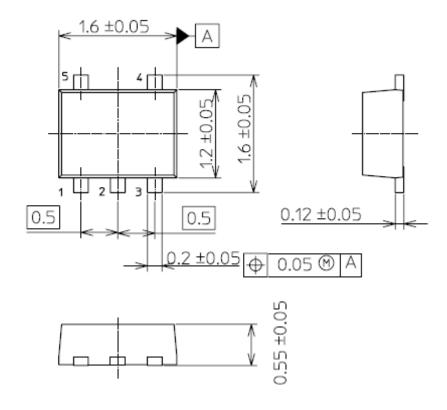


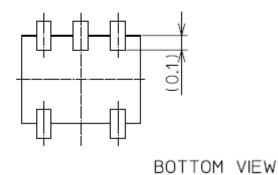


Weight: 16 mg (typ.)

Package Dimensions

ESV (SOT-553) Unit: mm





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Weight: 3.0 mg (typ.)



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